

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Patel, et al.

Art Unit: Not Yet Assigned

Serial No.:

10/627,155

Examiner: Not Yet Assigned

Filed: 7/24/03

For:

MICROMIRROR ARRAY DEVICE WITH A SMALL PITCH SIZE

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 CFR 1.97(b)

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Sir:

The attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached PTO Form 1449. Copies of the cited references are enclosed.

No fee or certification is required in connection with this Information Disclosure Statement, since it is being submitted prior to the last of (1) issuance of a first official action on the merits and (2) expiration of the three month period following filing of the above-captioned application.

The above information is presented so that the Patent and Trademark Office can determine any materiality thereof to the claimed invention. It is respectfully requested that the information be considered during the prosecution of this application and that the cited documents be listed on the front page of any patent issuing from this application.

The Patent Office is authorized to charge our Deposit Account No. 501516 for any fee which it deems to be required to effect consideration of this statement.

Respectfully submitted,

Gregory R. Mai

Attorney for Applicant(s) Registration No. 35,293

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Information Disclosure Statement w/PTO 1449 Form- 8 Pages Copies of Cited References Return Receipt Postcard Attorney Docket No. P102-US Serial No.: 10/627,155

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Complete if Known Substitute for form 1449A/PTO 10/627,155 **Application Number** INFORMATION DISCLOSURE 7/24/03 Filing Date First Named Inventor STATEMENT BY APPLICANT Patel Not Yet Assigned Art Unit (use as many sheets as necessary) Not Yet Assigned Examiner Name Attorney Docket Number P102-US of Sheet

		U.S. PAT	ENT DOCUMENTS	
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STATEMENT BY APPLICANT

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Application Number 10/627,155

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First Named Inventor Patel

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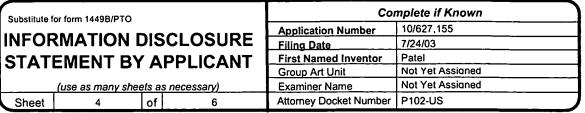
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